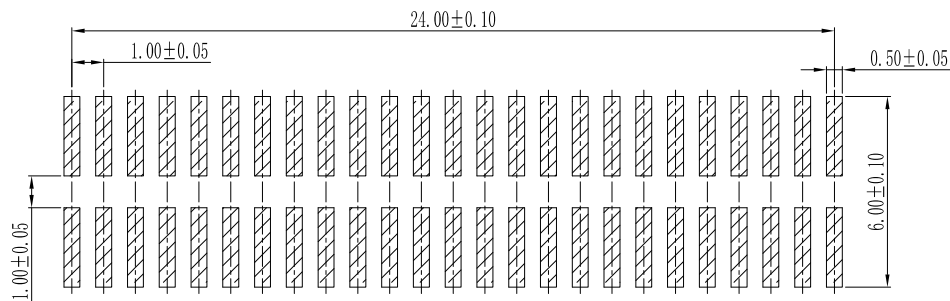
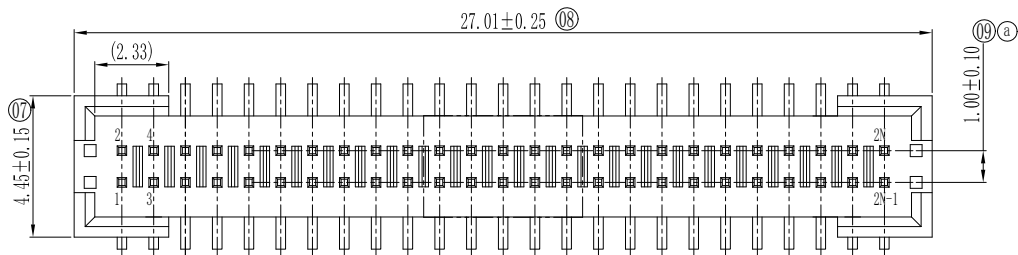
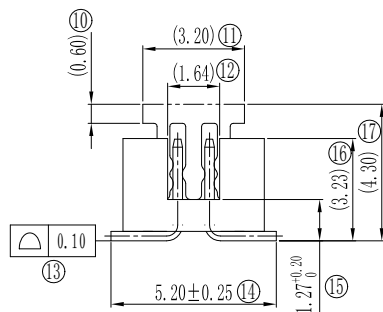
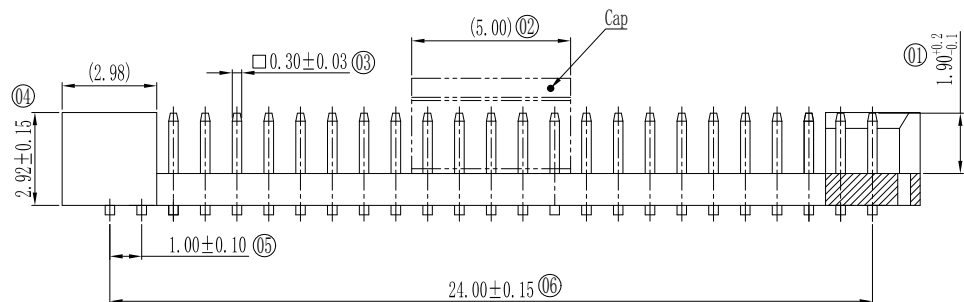




Recommended PCB Layout

Unless otherwise specified tolerance:

X.	±0.50	X. °	±3°
.X	±0.38	.X°	±2°
.XX	±0.25		

Performance characteristics:

1.Main body part material

Insulator: LCP Black,UL94V-0

① Contact terminal: Brass,1.27~3μm Ni under plated,outer contact area plating Au 0.76μm,tail plating Au 0.08~0.2μm

2.Electrical requirements:

Current rating: 1 A

Contact resistance: ≤15 mΩ

Insulation resistance: ≥1000 MΩ

Withstanding voltage: 500 Vr.m.s, 1mA, 60s

3.Mechanical requirements

Retention force: ≥1.5 N/pin

4.Environment specification

Working temperature: -40℃~105℃

Humidity: ≤93% at 40℃

Resistance to soldering heat: 260℃, 30s(SMT)

5.Packing & storing

Method of packing: Tape & Reel, outer box

Storing condition: temperature of -10℃~+55℃
below 80% relative humidity

7.Style of installation: SMT

8.To prevent the pollution of the environment product info

RoHS agreement:In line with the european union RoHS.

					1.00mm pitch double row SMT pin header CUSTOMER: HUAWEI	SL0. 1281. 007			
①	2	368302	ZhaoLin	2019.02.23		Projection	Rev.	Weight	Scale
Mark	NO.	File NO.	Signature	Date			A1		1:1
DRAW		ZhaoLin 2018.09.13							
CHK		Tim2019.3.30							
MAN		Spring2019.4.1							
STD		Alan2019.4.1			1281-254-D4-P	All Dimensions in mm		Sheet 1 of 1	
APP						 SHINNING SHENZHEN SHINNING ELECTRONIC CO.,LTD.			